

- ◆ N-Channel Power MOS FET
- ◆ DMOS Structure
- ◆ Low On-State Resistance : 0.02Ω (max)
- ◆ Ultra High-Speed Switching
- ◆ SOP - 8 Package

- Applications
- Notebook PCs
- Cellular and portable phones
- On - board power supplies
- Li - ion battery systems

General Description

The XP131A1520SR is a N-Channel Power MOS FET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. The small SOP-8 package makes high density mounting possible.

Features

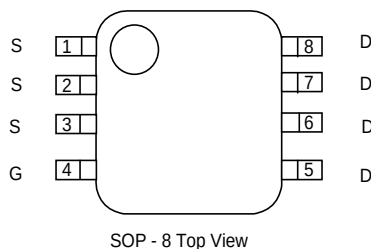
Low on-state resistance : $R_{ds(on)} = 0.015\Omega$ ($V_{gs} = 10V$)
 $R_{ds(on)} = 0.02\Omega$ ($V_{gs} = 4.5V$)

Ultra high-speed switching

Operational Voltage : 4.5V

High density mounting : SOP - 8

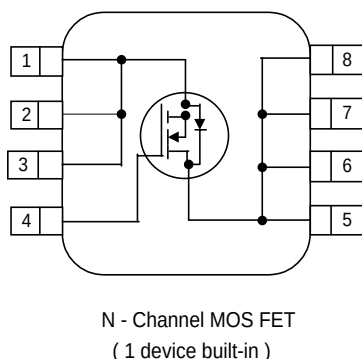
Pin Configuration



Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1 - 3	S	Source
4	G	Gate
5 - 8	D	Drain

Equivalent Circuit



Absolute Maximum Ratings

Ta=25°C			
PARAMETER	SYMBOL	RATINGS	UNITS
Drain - Source Voltage	Vdss	30	V
Gate - Source Voltage	Vgss	± 20	V
Drain Current (DC)	Id	10	A
Drain Current (Pulse)	Idp	40	A
Reverse Drain Current	Idr	10	A
Continuous Channel Power Dissipation (note)	Pd	2.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to 150	°C

(note) : When implemented on a glass epoxy PCB

Electrical Characteristics

DC characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Drain Cut-off Current	Idss	Vds = 30 , Vgs = 0V			10	μA
Gate-Source Leakage Current	Igss	Vgs = ± 20 , Vds = 0V			± 1	μA
Gate-Source Cut-off Voltage	Vgs (off)	Id = 1mA , Vds = 10V	1.0		2.5	V
Drain-Source On-state Resistance (note)	Rds (on)	Id = 5A , Vgs = 10V		0.012	0.015	Ω
		Id = 5A , Vgs = 4.5V		0.016	0.02	Ω
Forward Transfer Admittance (note)	Yfs	Id = 5A , Vds = 10V		20		S
Body Drain Diode Forward Voltage	Vf	If = 10A , Vgs = 0V		0.8	1.1	V

(note) : Effective during pulse test.

Dynamic characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Capacitance	Ciss	Vds = 10V , Vgs = 0V f = 1 MHz		1370		pF
Output Capacitance	Coss			740		pF
Feedback Capacitance	Crss			280		pF

Switching characteristics

Ta=25°C

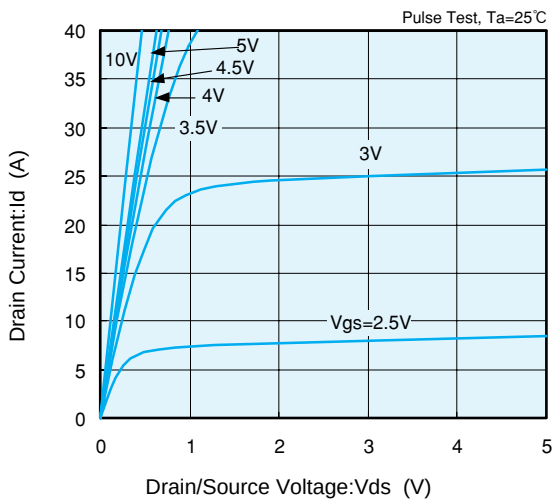
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Turn-on Delay Time	td (on)	Vgs = 5V , Id = 5A Vdd = 10V		20		ns
Rise Time	tr			25		ns
Turn-off Delay Time	td (off)			40		ns
Fall Time	tf			20		ns

Thermal characteristics

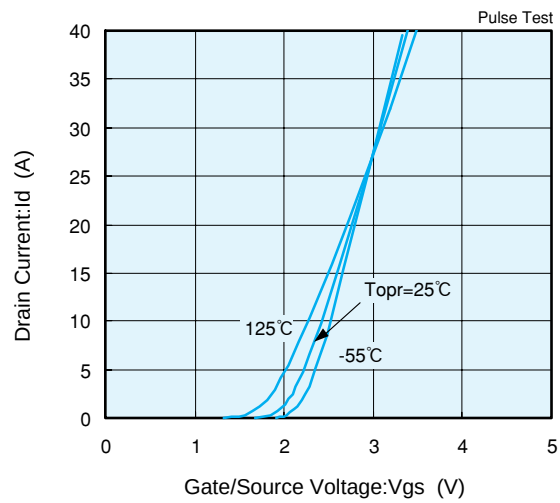
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Thermal Resistance (channel - surroundings)	Rth (ch - a)	Implement on a glass epoxy resin PCB		50		°C / W

Electrical Characteristics

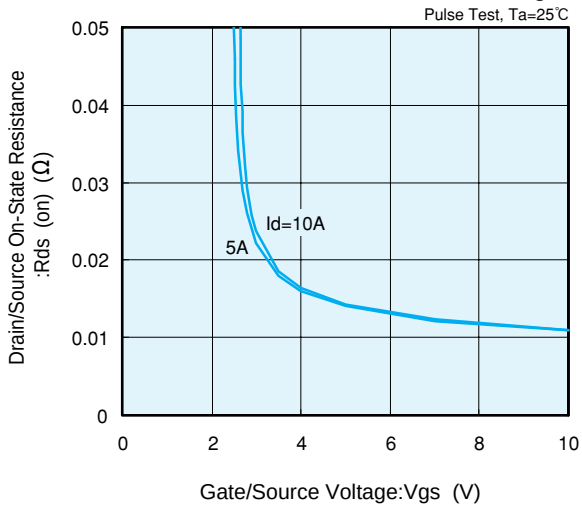
Drain Current vs. Drain/Source Voltage



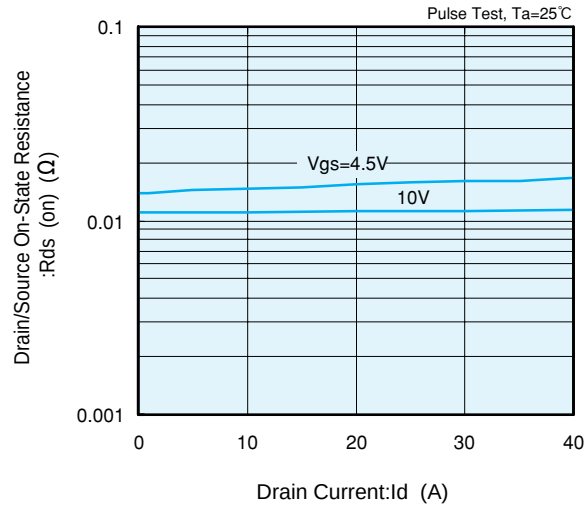
Drain Current vs. Gate/Source Voltage



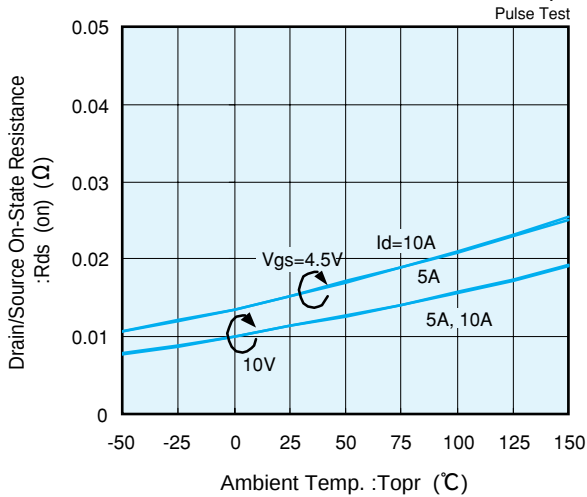
Drain/Source On-State Resistance vs. Gate/Source Voltage



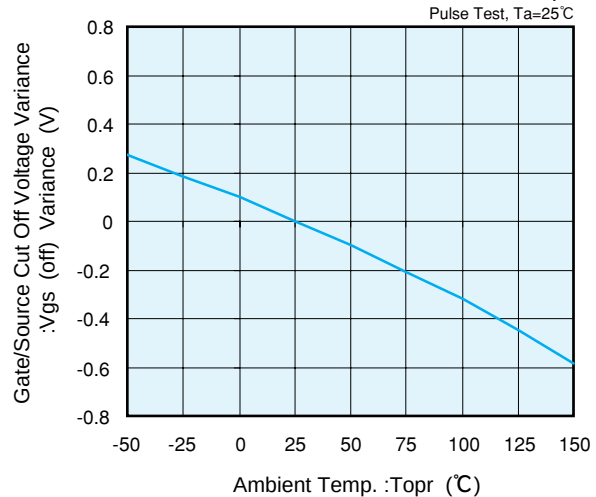
Drain/Source On-State Resistance vs. Drain Current



Drain/Source On-State Resistance vs. Ambient Temp.

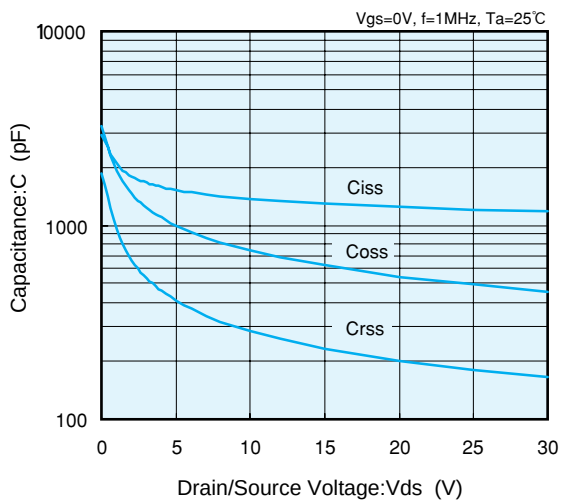


Gate/Source Cut Off Voltage Variance vs. Ambient Temp.

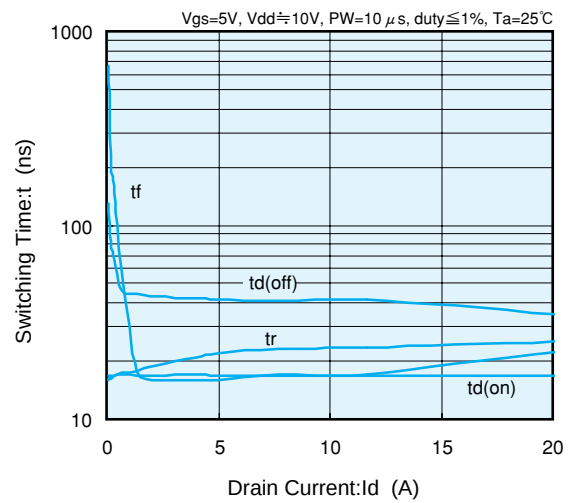


Electrical Characteristics

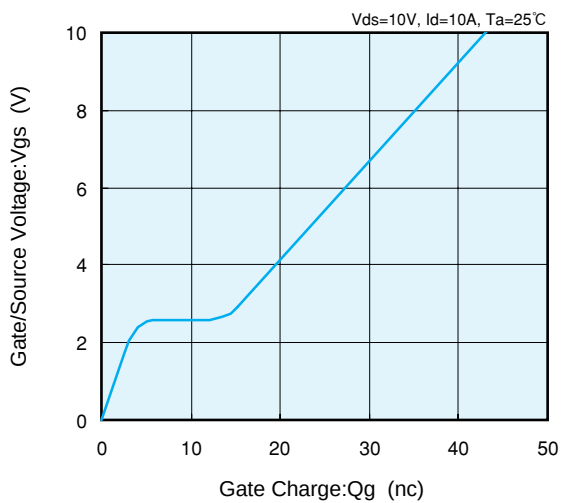
Capacitance vs. Drain/Source Voltage



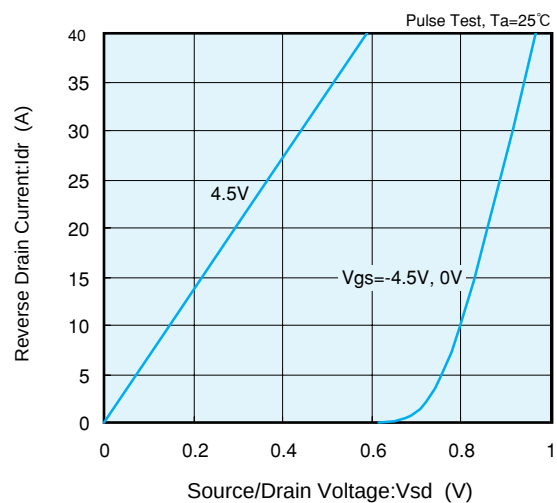
Switching Time vs. Drain Current



Gate/Source Voltage vs. Gate Charge



Reverse Drain Current vs. Source/Drain Voltage



Standardized Transition Thermal Resistance vs. Pulse Width

